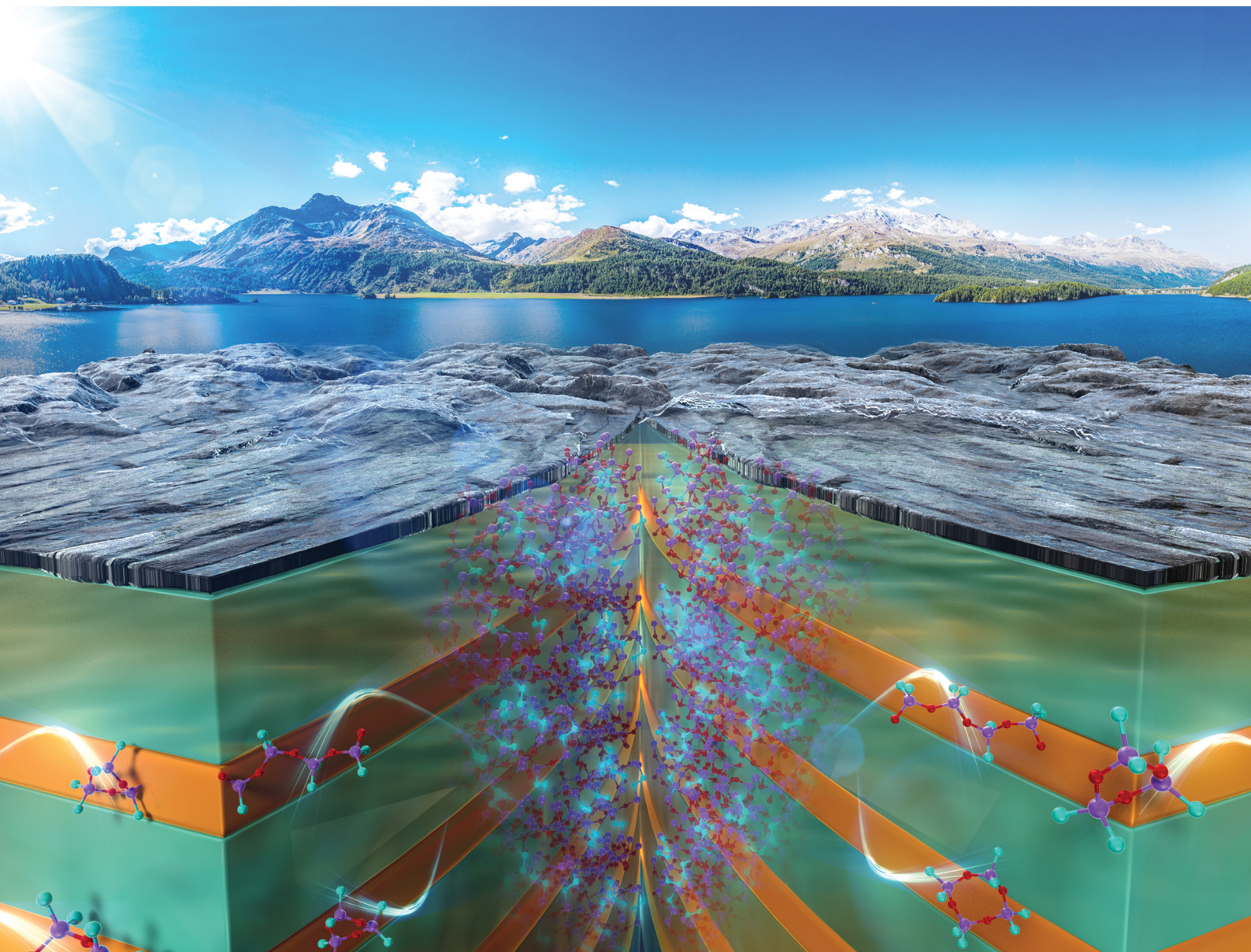


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Multilayered organosiloxane films with self-healing ability converted from block copolymer nanocomposites†

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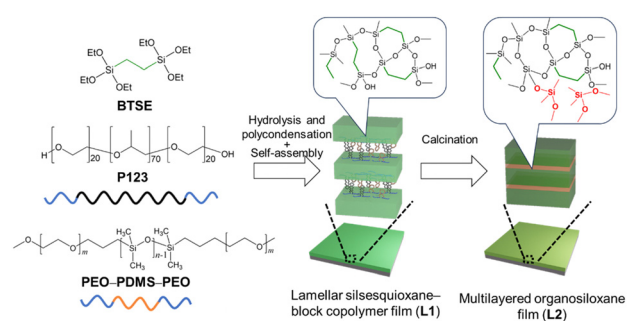
Self-healable, multilayered organosiloxane films were prepared via thermal conversion of lamellar organosiloxane films containing poly(ethylene oxide)–polydimethylsiloxane–poly(ethylene oxide) block copolymers. The incorporation of silanolate groups enabled crack healing through dynamic siloxane equilibration. The enhanced hardness and suppressed cyclic siloxane formation resulting from the multilayered structure exhibit potential for practical applications.

Polysiloxane materials are utilized in various fields, including optics, electronics, and aerospace, owing to their transparency, excellent thermal stability, weather resistance, and insulating properties.^{1–4} The dynamic nature of the Si–O–Si bonds, which impart self-healing properties, has recently gained considerable attention.^{3,5} In particular, polydimethylsiloxane (PDMS)-based elastomers with silanolate (Si–O[−]) end groups exhibit self-healing behavior through thermally activated equilibration among different siloxane chains.^{6,7} However, the formation and volatilization of low-molecular-weight cyclic siloxanes⁶ compromise the long-term stability of these materials and cause serious problems, such as contact failures in electronic components.^{5,8,9} Another significant issue is the enhancement of their mechanical properties, such as hardness, of the self-healing siloxane materials, particularly for their application in coatings.

The incorporation of inorganic nanofillers such as nanoparticles and nanosheets can generally improve the physical properties of polymer materials effectively. Nanocomposites of polymers and inorganic nanosheets have been reported to exhibit high mechanical strength, incombustibility, and gas-barrier properties.^{10,11} Furthermore, layer-by-layer-assembled

nanocomposite films containing polymers (poly(vinyl alcohol)) and inorganic nanosheets (boron nitride) exhibit improved self-healing abilities owing to the in-plane anisotropic diffusion of the polymers.¹² These features of multilayered nanocomposites greatly contribute to addressing the aforementioned issues of self-healing PDMS-based materials. However, one challenge is that stable linkages between PDMS and the nanosheet surface are required to prevent segregation due to the low surface energy of PDMS. Additionally, developing a more efficient approach for multilayered films than the conventional layer-by-layer assembly method^{12–14} is important from both scientific and practical viewpoints.

Herein, we report an efficient approach for fabricating multilayered films composed of organosiloxane and grafted PDMS layers through the thermal conversion of a lamellar silsesquioxane ($(O_{1.5}Si-C_2H_4-SiO_{1.5})_n$) thin film containing a poly(ethylene oxide)–PDMS–poly(ethylene oxide) block copolymer (PEO–PDMS–PEO) (Scheme 1). Lamellar thin films were prepared by an evaporation-induced self-assembly process starting with 1,2-bis(triethoxysilyl)ethane (BTSE), PEO–poly(propylene oxide) (PPO)–PEO triblock copolymer (Pluronic P123), and PEO–PDMS–PEO. By selectively removing the PEO and PPO blocks *via* calcination, we successfully obtained a multilayered siloxane film with a crack healing ability, exhibiting higher hardness and significantly



Scheme 1 Preparation of multilayered organosiloxane films via the conversion of organosiloxane–block copolymer nanocomposites.

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lower volatilization of cyclic oligomers than previously reported self-healing PDMS-based elastomers.

PEO-PDMS-PEO (PEO₂₇-PDMS₃₆-PEO₂₇) was synthesized according to the literature¹⁵ with some modifications (see ESI† for details). A transparent thin film with a lamellar structure (**L1**, Fig. 1a(i)) was prepared by spin-coating or drop-casting a precursor solution with a molar composition of BTSE : P123 : PEO₂₇-PDMS₃₆-PEO₂₇ : EtOH : H₂O : HCl = 1 : 0.015 : 0.015 : 15 : 20 : 0.008 onto silicon or glass substrates (see ESI† for details).

The X-ray diffraction (XRD) pattern of **L1** (Fig. 1b(i)) shows a sharp peak at *d* spacing of 10.27 nm with second- and third-order diffractions. The grazing-incidence small-angle X-ray scattering (GI-SAXS) pattern (Fig. 1c(i)) shows a spot corresponding to the periodicity of the same *d* spacing along the direction perpendicular to the substrate surface, indicating the formation of a lamellar mesostructure oriented parallel to the substrate. The thickness of **L1** was approximately 800 nm, as confirmed by scanning electron microscopy (SEM) analysis of the fractured surface (Fig. S1, ESI†). The control of the molar ratio of BTSE to block copolymers is crucial for the formation of the lamellar structure. For example, a two-dimensional hexagonal structure was formed with a molar ratio of BTSE : P123 : PEO₂₇-PDMS₃₆-PEO₂₇ = 1 : 0.01 : 0.01 (Fig. S2, ESI†).

The Fourier transform infrared (FT-IR) spectrum of **L1** (Fig. S3, ESI†) shows absorption bands attributed to Si-O-Si (1000–1100 cm⁻¹), C-O (1100–1200 cm⁻¹), and Si-CH₃ (1250 cm⁻¹), suggesting the formation of a composite of siloxane and block copolymers. The solid-state ²⁹Si magic-angle spinning (MAS) nuclear magnetic resonance (NMR) spectrum of **L1** (Fig. 1d(i)) exhibits a sharp D² signal (D^x: Me₂Si(OSi)_x(OH)_{2-x}, -22 ppm) corresponding to the PDMS block and broad T¹, T², and T³ signals (T^y: CSi(OSi)_y(OH)_{3-y}, -51, -55, and -62 ppm, respectively) derived

from BTSE. The D/T integral ratio was 20 : 79, which is consistent with the molar ratio of PEO₂₇-PDMS₃₆-PEO₂₇/BTSE = 0.015 in the precursor solution. The solid-state ¹³C MAS NMR spectrum (Fig. 1e(i)) shows signals assigned to the PEO and PPO blocks (16–22 ppm and 67–78 ppm), along with the signals of the SiCH₃ and SiC₂H₄Si groups (0–5 ppm) derived from PDMS and BTSE, respectively. These results indicate that **L1** has a lamellar structure consisting of BTSE-derived silsesquioxane and block copolymer layers (P123 and PEO₂₇-PDMS₃₆-PEO₂₇) (Scheme 1, middle).

PEO and PPO blocks were selectively removed from lamellar film **L1** to produce a multilayered siloxane film composed of silsesquioxane and PDMS. The thermogravimetry-differential thermal analysis (TG-DTA) curves of **L1** (Fig. S4, ESI†) show exothermic peaks with weight loss due to the combustion of PEO and PPO blocks at 130–250 °C.¹⁶ The SiC₂H₄Si groups in the silsesquioxane layers and SiCH₃ groups of PDMS combusted at higher temperatures (>250 °C). Similar degradation behavior of the PEO blocks was also observed for PEO₂₇-PDMS₃₆-PEO₂₇ (Fig. S5, ESI†). Based on these data, **L1** was calcined in air at 170 °C for 4 h to remove the PEO and PPO blocks. The resulting calcined film (hereafter referred to as **L2**) was transparent and colorless, and no cracks were observed (Fig. 1a(ii)).

The FT-IR spectrum of **L2** (Fig. S3(ii), ESI†) shows a decrease in the bands corresponding to the PEO and PPO blocks. The selective removal of the PEO and PPO blocks was confirmed from the ¹³C MAS NMR spectrum of **L2** (Fig. 1e(ii)). The signals of the PEO and PPO blocks decreased significantly compared to those of the SiCH₃ and SiC₂H₄Si groups. The ²⁹Si MAS NMR analysis of **L2** (Fig. 1d(ii)) confirmed that the D² signal remained almost unchanged, whereas the integrated intensity of the T signals decreased slightly and a broad Q³ signal (Si(OSi)₃OH, -100 ppm) appeared. This result indicates that the O₃SiC₂H₄SiO₃ units were partially cleaved to form SiO₄ units, which may be due to the increase in the local temperature around the silsesquioxane layers upon the combustion of the PEO and PPO blocks of the block copolymers.

PDMS is known to degrade thermally through backbiting and chain transfer, resulting in evaporation of low-molecular-weight cyclic siloxanes.^{17,18} In the ²⁹Si MAS NMR spectrum of **L2**, the signals of cyclic tetrasiloxane (-19 ppm)¹⁹ and cyclic trisiloxane (-9 ppm)¹⁹ were not observed (Fig. 1d(ii)). In addition, the integral ratio of the D units to total Si (D + T + Q) was almost unchanged from that of **L1** (Fig. 1d). Therefore, the formation and evaporation of these cyclic siloxanes were negligible upon calcination at 170 °C. The decrease in the relative intensity of the ²⁹Si NMR signal (9 ppm) corresponding to the terminal OSiMe₂CH₂- groups in PEO-PDMS-PEO (Fig. 1d) suggested that the PDMS blocks formed higher molecular-weight linear/cyclic siloxanes and/or linkages with the T and Q units.

The XRD pattern of **L2** (Fig. 1b(ii)) shows a diffraction peak at *d* = 5.18 nm. The GI-SAXS pattern (Fig. 1c(ii)) shows a spot corresponding to an oriented lamellar structure with a reduced *d* spacing. These results indicate that a lamellar film consisting of partially decomposed silsesquioxane and PDMS layers was formed. The *d* spacing of **L1** decreased to 4.37 nm after removal

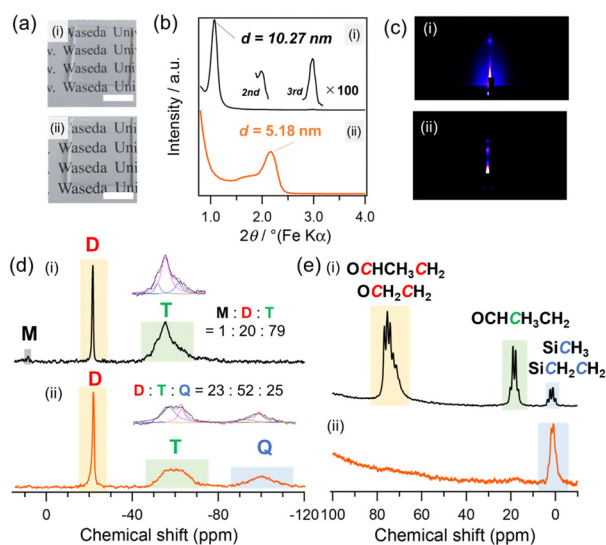


Fig. 1 (a) Photographs of (i) **L1** and (ii) **L2** prepared on glass substrates (2 cm × 2 cm) by spin-coating. (b) XRD patterns and (c) GI-SAXS patterns of (i) **L1** and (ii) **L2** prepared on Si substrates by spin-coating. (d) ²⁹Si MAS NMR and (e) ¹³C MAS NMR spectra of (i) **L1** and (ii) **L2** prepared by drop-casting the precursor solution on the substrates, followed by drying and pulverization.



of the block copolymers (P123 and PEO-PPO-PEO) by solvent extraction (Fig. S6, ESI†). Assuming that the thickness of the silsesquioxane layers in **L2** is 4 nm, the volume ratio of the silsesquioxane-based layers to the PDMS layers is approximately 4:1 (Scheme 1, right). No decrease in the *d* spacing of **L2** was observed even after swelling in THF and subsequent drying (Fig. S7, ESI†). This result suggested that PDMS chains are partially grafted to the silsesquioxane layers. The volume ratio of PDMS can be varied using PEO-PDMS-PEO with different block lengths. A similar multilayered siloxane film prepared using PEO₂₇-PDMS₈₂-PEO₂₇ exhibited a larger *d* spacing (7.11 nm) compared to that of **L2** (Fig. S8, ESI†), which suggested the formation of thicker PDMS layers.

Several reports have shown that Si-O-Si bonds behave as dynamic bonds in the presence of nucleophiles such as silanolate and amines. These can induce the rearrangement of siloxane bonds by nucleophilic attack on other Si atoms or by reacting with residual silanol.^{5,20–22} Therefore, we introduced silanolate groups into **L2** by immersing the film in a THF-water solution of KOH. The resulting film is referred to as **L3**. The X-ray photoelectron spectroscopy (XPS) depth profiles (Fig. S9, ESI†) of **L3** revealed a uniform distribution of K on the surface for a depth of about 100 nm, which was not observed in **L2**. ²⁹Si MAS NMR and ¹³C MAS NMR analyses confirmed that the silsesquioxane and PDMS moieties remained almost intact (Fig. S10 and S11, ESI†). The retention of the lamellar structure was confirmed by XRD and GI-SAXS (Fig. S12, ESI†). Cross-sectional scanning transmission electron microscopy (STEM) images of **L3** cut vertically using focused ion beam milling revealed oriented layered patterns (Fig. S13, ESI†).

The healing of cracks, which were submicrometers in width and several micrometers in length, that were made on **L3** was observed after treating the film at 80 °C and 40% relative humidity (RH) for 1 d (Fig. 2). Under these conditions, the layered structure of **L3** was retained with a slight decrease in the *d* spacing (Fig. S14, ESI†). Cross-sectional TEM and STEM images and energy-dispersive X-ray spectroscopy mapping of the healed area suggested that the crack was filled with siloxane species with no layered structure (Fig. S15, ESI†).

We confirmed that crack healing did not occur when **L2** (without KOH) was treated under the similar conditions or

when **L3** was heated without increasing the humidity. It is reasonable to consider that the healing occurred *via* rearrangement of the siloxane networks mediated not only by potassium silanolate groups but also by silanol groups formed by partial hydrolysis of the Si-O-Si bonds.⁵ Healing was not observed for **L3** at room temperature even at 90% RH, which is in contrast to room-temperature healing reported for PDMS elastomers with lower degrees of cross-linking.²⁰ The heating and humid conditions required for the crack healing of **L3** are likely due to the presence of a silsesquioxane layer with a high cross-linking density.

To verify the effects of the siloxane components on the healing behaviors, a multilayered film was prepared using tetraethoxysilane (TEOS) instead of BTSE under otherwise identical conditions. A lamellar thin film with *d* = 8.95 nm was formed by spin-coating. After calcination and introduction of KOH, the resulting layered silica-PDMS thin film exhibited a crack healing behavior (experimental details and Fig. S16, ESI†). These results suggest that the composition of the siloxane layers is tunable.

Our previous study showed that lamellar silica/silsesquioxane-surfactant composite films exhibit crack-healing abilities under humid conditions, even at room temperature.^{23,24} This healing mechanism is attributed to the lamellar swelling caused by water adsorption in the surfactant layers to induce crack closure, which fundamentally differs from the siloxane equilibration-induced healing of **L3**. The presence of quaternary ammonium cations or block copolymers between layers inevitably reduces their durability and mechanical strength. In contrast, the multilayered siloxane film **L3** is an all-siloxane material that contains no interlayer organic molecules or polymers and exhibits excellent properties inherent to siloxanes, such as high thermal stability and weather resistance.

Nanoindentation tests revealed that **L3** had a hardness of 1.50 GPa (Fig. S17, ESI†). This value is much higher than that of a conventional PDMS elastomer (49 MPa), which may be due to the presence of more rigid silsesquioxane layers. The value is also much higher than that of self-healing silsesquioxane-surfactant lamellar thin films that heal under humid conditions (261 MPa). In addition, the significant increase in hardness from **L1** (112 MPa) can be attributed to the increased volume ratio of the silsesquioxane layers caused by the removal of the PEO and PPO moieties.

The TG-mass spectrometry (TG-MS) analysis was conducted to evaluate the release of low-molecular-weight cyclic siloxanes formed through siloxane equilibration (Fig. S18, ESI†). The self-healing PDMS elastomer exhibited degradation starting at 80 °C, and fragment ion peaks derived from cyclic hexamethyltrisiloxane (D3) and octamethyltetrasiloxane (D4) were detected up to 180 °C. Meanwhile, **L3** exhibited relatively moderate weight loss at elevated temperatures. Importantly, no mass peaks derived from cyclic siloxanes were observed for **L3**, as the silsesquioxane layers likely blocked the release of volatile cyclic siloxanes from the interlayer space.

This material (**L3**) is promising as protective coatings because of its high hardness, crack-healing ability, suppressed cyclic siloxane volatilization, and transparency. The low-volatilization

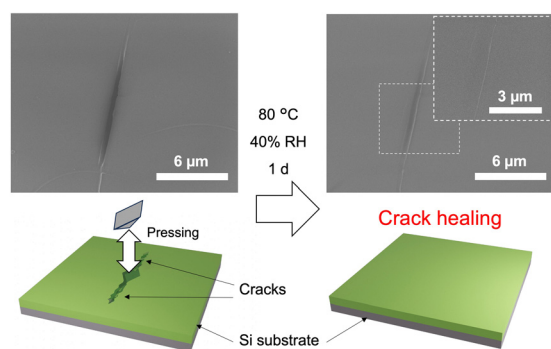


Fig. 2 Crack healing behavior of **L3** at 80 °C and 40% RH. The crack was created by pressing a diamond indenter on the film. The surface of the thin film before and after healing was observed by SEM.



property also makes it suitable for electronic components that are sensitive to contamination risks. However, the processes involving KOH and H₂O could pose challenges for practical applications. Further materials design is required to achieve crack healing under milder conditions.

In conclusion, a new class of self-healing siloxane materials composed of silsesquioxane and grafted PDMS layers was successfully prepared by the thermal conversion of a lamellar silsesquioxane film containing PEO–PDMS–PEO block copolymers. The multilayered structure of the material provides higher hardness and thermal stability than conventional self-healing PDMS-based materials. These findings contribute to the development of self-healing siloxane-based materials.

This work utilized research equipment JEOL JNM-ECX-400 (C1025), JEOL JNM-ECZ500R (C1028), BRUKER Dektak XT-S (C1049) ULVAC-PHI VersaProbe II (C1051), JEOL JEM-2100F (G1026), Hitachi S-5500 (G1028), JEOL JIB-4000 (G1033), Rigaku RINT Ultima IV (G1036), and Shimadzu HMV-2000 (G1064) shared in the MEXT Project for promoting the public utilization of advanced research infrastructure (Program for supporting construction of core facilities) Grant Number JPMXS0440500024. The authors are grateful to Mr T. Goto (Material Characterization Central Laboratory, Waseda University) for the XPS analysis, Dr N. Hanzawa, Mr T. Akanuma, and Ms M. Itadani (Kagami Memorial Research Institute for Materials Science and Technology) for the STEM observation. We gratefully acknowledge Mr T. Hikino, Mr T. Miyake and Ms R. Wakino (Waseda University) for the useful discussions.

Yoshiaki Miyamoto: conceptualization, all experimental data collection, writing – original draft and editing. Takamichi Matsuno: analysis, writing – review & editing. Atsushi Shimojima: writing – review & editing, supervision.

Data availability

The data supporting this article have been included as part of the ESI.†

Conflicts of interest

There are no conflicts to declare.

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